

1. Product Features

1.1 Electrical features

- $V_{CES}=1200V$
- $I_{C\ nom}=600A / I_{CRM}=1200A$
- Low switching losses
- Low inductance
- Fast switching and short tail current
- High power and thermal cycling capability



Figure1 IGBT Module

1.2 Mechanical features

- High power and thermal cycling capability
- Al_2O_3 substrate with low thermal resistance
- Copper base plate

2. Typical Applications

- Switching mode power supply
- Drive inverters with brake system
- Uninterruptible power supply
- AC and DC servo drive amplifier

3. Description

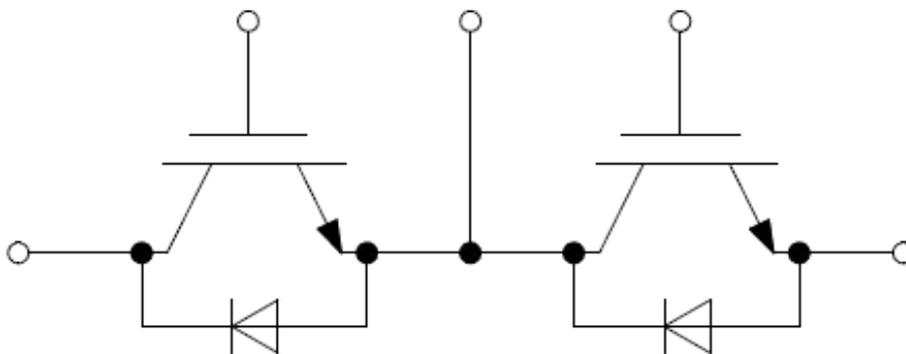


Figure 2 Half Bridge

4. IGBT, Inverter

4.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Collector-emitter voltage 集电极—发射极间电压	$T_{vj} = 25^{\circ}\text{C}$	V_{CES}	1200	V
Continuous DC collector current 连续集电极电流	$T_C = 100^{\circ}\text{C}, T_{vj, \max} = 150^{\circ}\text{C}$	$I_{C \text{ nom}}$	600	A
Repetitive peak collector current 集电极峰值电流	$t_p = 1 \text{ ms}$	I_{CRM}	1200	A
Total power dissipation 总功率损耗	$T_C = 25^{\circ}\text{C}, T_{vj, \max} = 175$	P_{tot}	1875	W
Gate-emitter peak voltage 栅极—发射极峰值电压		V_{GES}	+/- 20	V

4.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter saturation voltage 集电极—发射极饱和电压	$I_C = 600 \text{ A}, V_{GE} = 15 \text{ V}$	$T_{vj} = 25^{\circ}\text{C}$		1.45	1.90	V
		$T_{vj} = 125^{\circ}\text{C}$		1.60		V
		$T_{vj} = 150^{\circ}\text{C}$		1.65		V
Gate threshold voltage 栅极阈值电压	$I_C = 22.8 \text{ mA}, V_{CE} = V_{GE}, T_{vj} = 25^{\circ}\text{C}$	$V_{GE, \text{th}}$	5.0	5.8	6.5	V
Gate charge 栅极电荷	$V_{GE} = -15 \text{ V} \dots +15 \text{ V}$	Q_G		6.9		μC
Internal gate resistor 内部栅极电阻	$T_{vj} = 25^{\circ}\text{C}$	$R_{G \text{ int}}$		0.53		Ω
Input capacitance 输入电容	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{ies}		86		nF
Reverse transfer capacitance 反向传输电容	$f = 1 \text{ MHz}, T_{vj} = 25^{\circ}\text{C}, V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}$	C_{res}		0.6		nF
Collector-emitter cut-off current 集电极-发射极截止电流	$V_{CE} = 1200 \text{ V}, V_{GE} = 0 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{CES}			4	mA
Gate-emitter leakage current 栅极-发射极漏电流	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}, T_{vj} = 25^{\circ}\text{C}$	I_{GES}			400	nA
Turn-on delay time, inductive load 开通延迟时间	$I_C = 600 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, \text{on}} = 1.6 \Omega$	$T_{vj} = 25^{\circ}\text{C}$		0.19		us
		$T_{vj} = 125^{\circ}$		0.19		us
		$T_{vj} = 150^{\circ}\text{C}$		0.20		us
Rise time, inductive load 上升时间	$I_C = 600 \text{ A}, V_{CE} = 600 \text{ V}$ $V_{GE} = +15/-15 \text{ V}$ $R_{G, \text{on}} = 1.6 \Omega$	$T_{vj} = 25^{\circ}\text{C}$		0.11		us
		$T_{vj} = 125^{\circ}\text{C}$		0.11		us
		$T_{vj} = 150^{\circ}\text{C}$		0.11		us

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Turn-off delay time, inductive load 关断延迟时间	$I_C = 600A, V_{CE} = 600V$	$T_{vj} = 25^\circ C$		0.60		us
	$V_{GE} = +15/-15V$	$T_{vj} = 125^\circ C$	$t_{d,off}$	0.60		us
	$R_{G,off} = 1.6\Omega$	$T_{vj} = 150^\circ C$		0.62		us
Fall time, inductive load 下降时间	$I_C = 600A, V_{CE} = 600V$	$T_{vj} = 25^\circ C$		0.15		us
	$V_{GE} = +15/-15V$	$T_{vj} = 125^\circ C$	t_f	0.31		us
	$R_{G,off} = 1.6\Omega$	$T_{vj} = 150^\circ C$		0.33		us
Turn-on energy loss per pulse 开通能量	$I_C = 600A, V_{CE} = 600V, L_s = 20nH$	$T_{vj} = 25^\circ C$		51.9		mJ
	$V_{GE} = +15/-15V, di/dt = 4300A/\mu s$	$T_{vj} = 125^\circ C$	E_{on}	52.6		mJ
	$R_{G,on} = 1.6\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		57.2		mJ
Turn-off energy loss per pulse 关断能量	$I_C = 600A, V_{CE} = 600V, L_s = 20nH$	$T_{vj} = 25^\circ C$		69.3		mJ
	$V_{GE} = +15/-15V, dv/dt = 3500V/\mu s$	$T_{vj} = 125^\circ C$	E_{off}	81.7		mJ
	$R_{G,off} = 1.6\Omega (T_{vj} = 150^\circ C)$	$T_{vj} = 150^\circ C$		88.0		mJ
SC data 短路数据	$V_{GE} \leq 15V, V_{CC} = 600V, t_p \leq 8\mu s, T_{vj} = 150^\circ C, C_{GE} = 0.0\mu F, V_{CEmax} = V_{CES} - L_{SCE} \cdot di/dt$		I_{SC}	3100		A
Thermal resistance, junction to case 结-外壳热阻	Per IGBT		$R_{th,jc}$		0.08	K/W

5. Diode, Inverter

5.1 Maximum Rated Values

Parameter	Note or test condition	Symbol	Values	Unit
Repetitive peak reverse voltage 反向重复峰值电压	$T_{vj} = 25^\circ C$	V_{RRM}	1200	V
Continuous DC forward current 连续正向直流电流		I_F	600	A
Repetitive peak forward current 正向重复峰值电流	$t_p = 1ms$	I_{FRM}	1200	A

5.2 Characteristic value

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Forward voltage 正向电压	$I_F = 600A, V_{GE} = 0V$	V_F		2.00	2.40	V
			$T_{vj} = 25^\circ C$			
			$T_{vj} = 125^\circ C$	1.65		V
			$T_{vj} = 150^\circ C$	1.60		V

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Peak reverse recovery current 反向恢复峰值电流	$I_F = 600A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 1750 A/\mu s$ $(T_{vj}=150^\circ C)$	I_{RM}		290		A
				480		A
				520		A
Recovered charge 恢复电荷	$I_F = 600A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 1750 A/\mu s$ $(T_{vj}=150^\circ C)$	Q_r		38.4		μC
				96.5		μC
				118.0		μC
Reverse recovery energy 反向恢复损耗 (每脉冲)	$I_F = 600A, V_R = 600V$ $V_{GE} = -15V, -di_F/dt = 1750 A/\mu s$ $(T_{vj}=150^\circ C)$	E_{rec}		10.7		mJ
				27.0		mJ
				32.8		mJ
Thermal resistance, junction to case 结-外壳热阻	Per diode	$R_{th,jc}$			0.10	K/W

6. Module

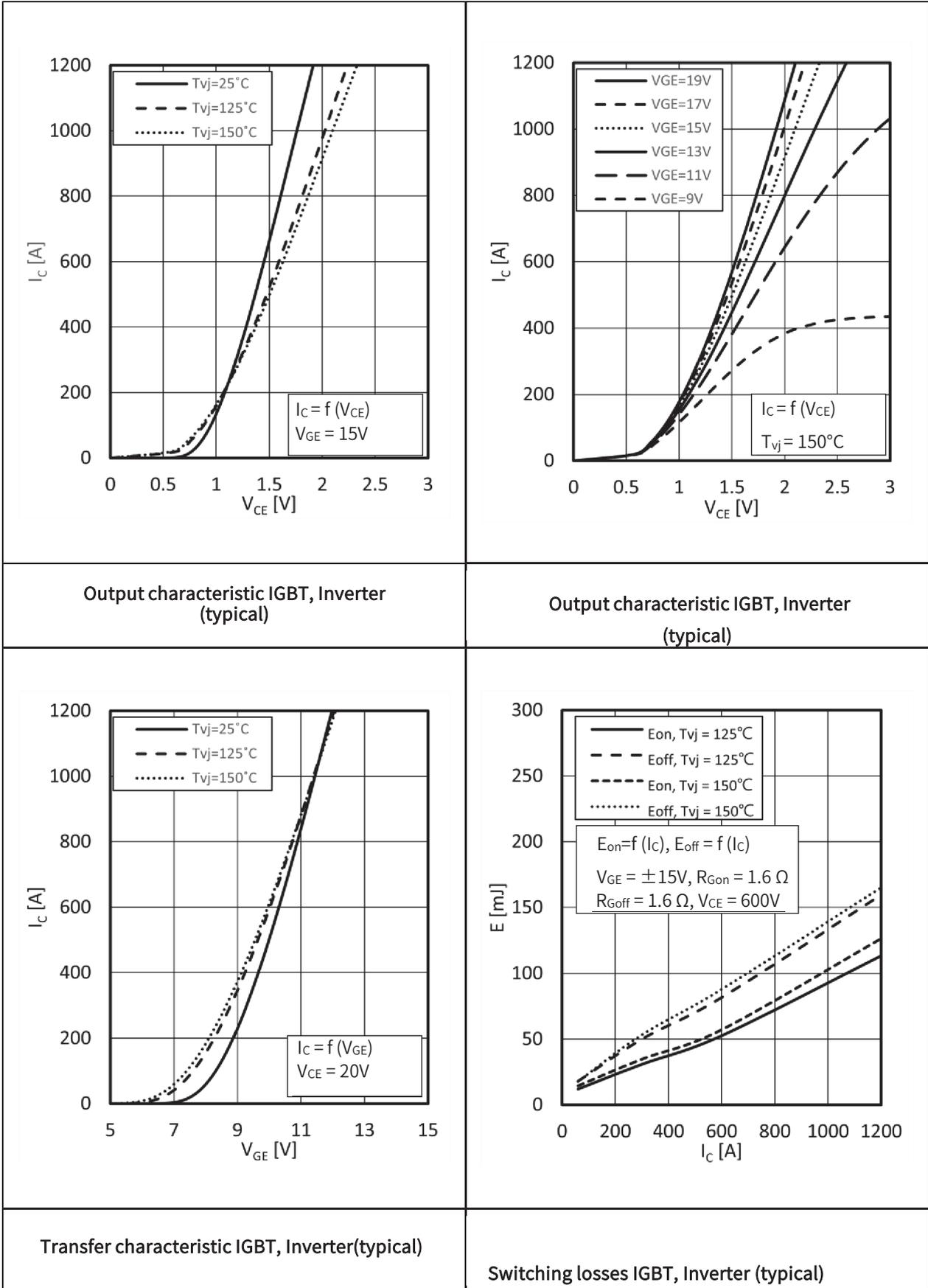
6.1 Characteristic value

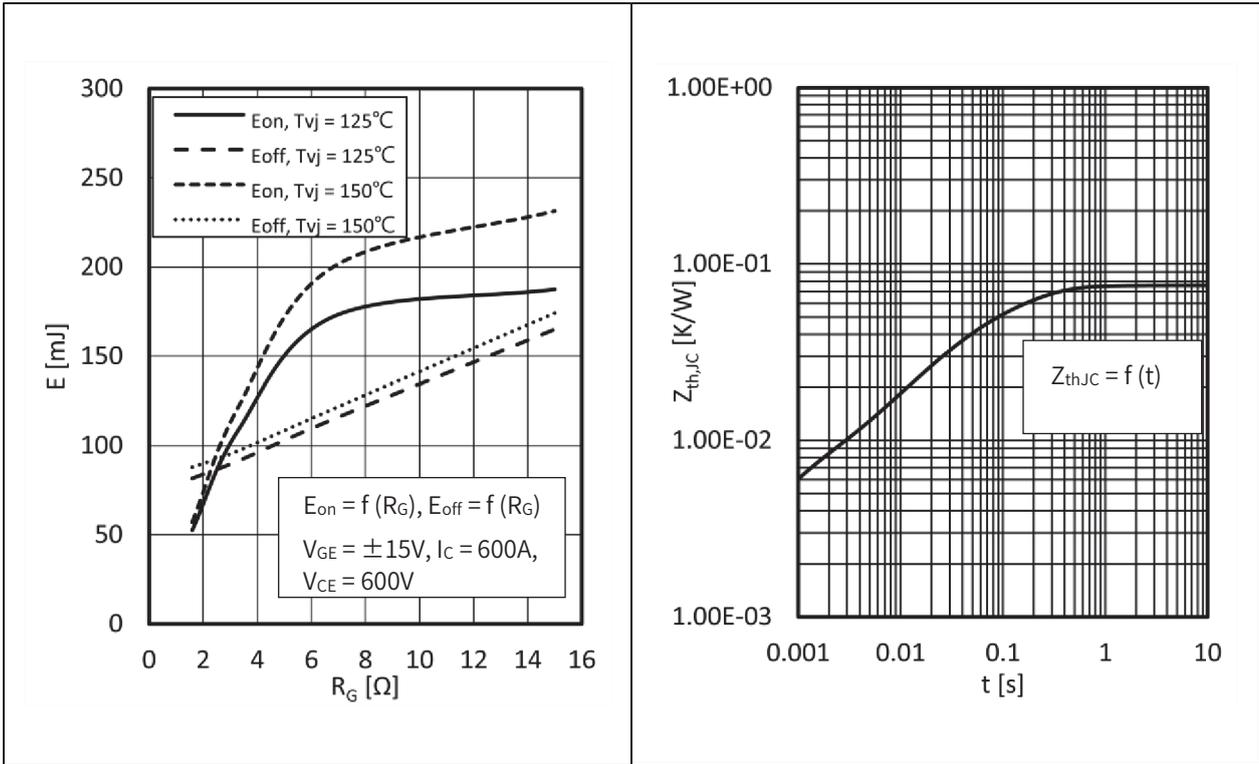
Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Isolation Voltage 隔离电压	RMS, f=50HZ,1min	V_{ISOL}			2500	V
Stray inductance module 杂散电感		L_{SCE}		20		nH

(table continues...) 待续

Parameter	Note or test condition	Symbol	Values			Unit
			Min.	Typ.	Max.	
Operation Junction Temperature 结温		T_{jop}	-40		150	$^\circ C$
Storage Temperature Range 存储温度范围		T_{stg}	-40		125	$^\circ C$
Mounting Torque 安装扭矩	Screw M6	M	3		6	N.m
Terminal Connection Torque 端子速接扭矩	Screw M6	M	2.5		5	N.m
Weight of Module 重量		G		340		g

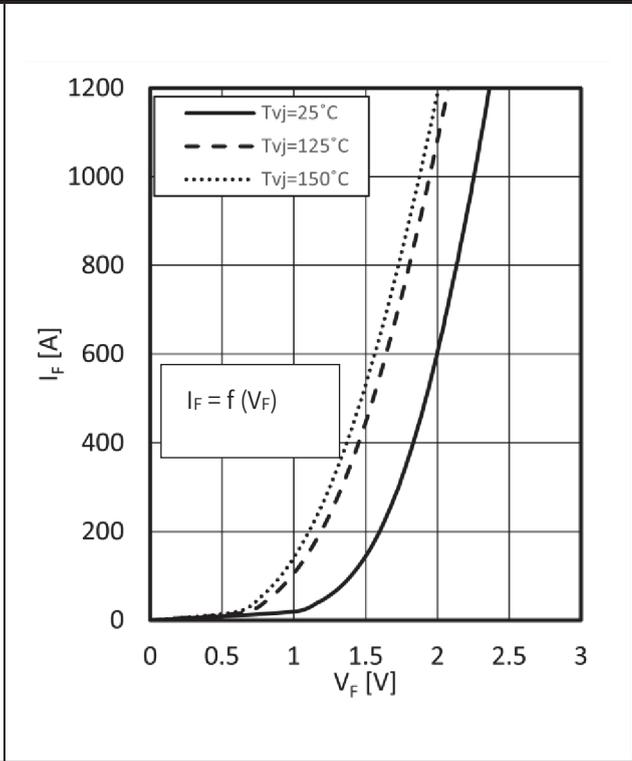
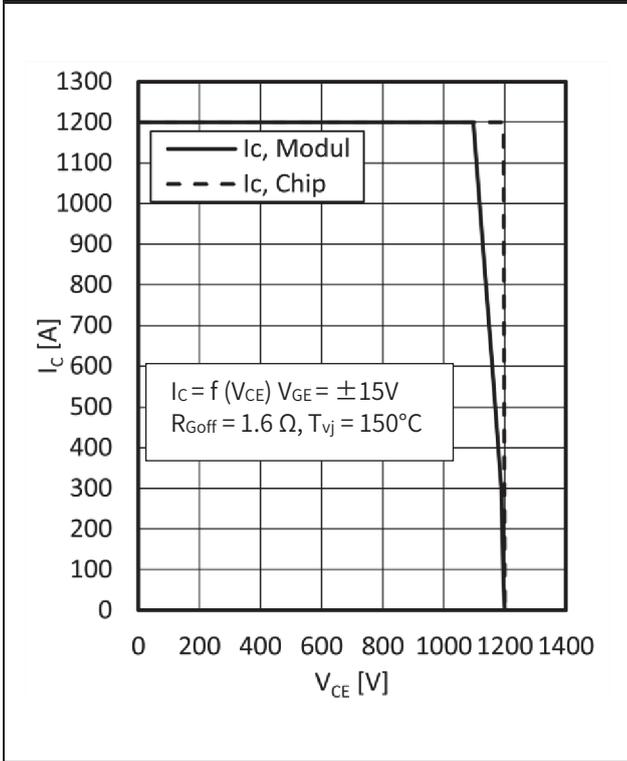
7. Characteristics diagrams





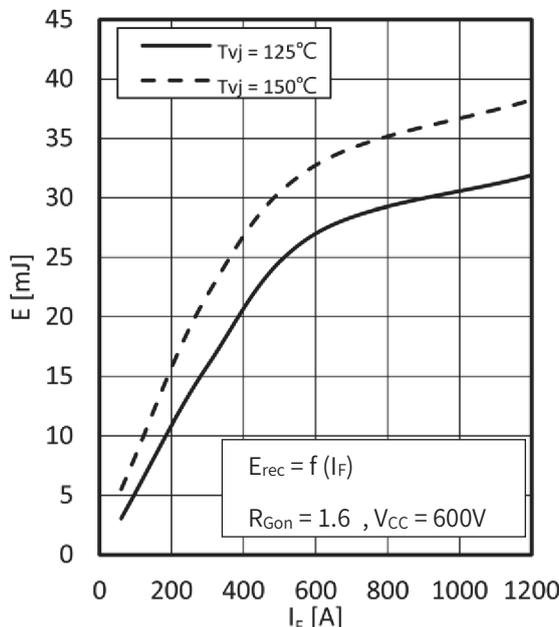
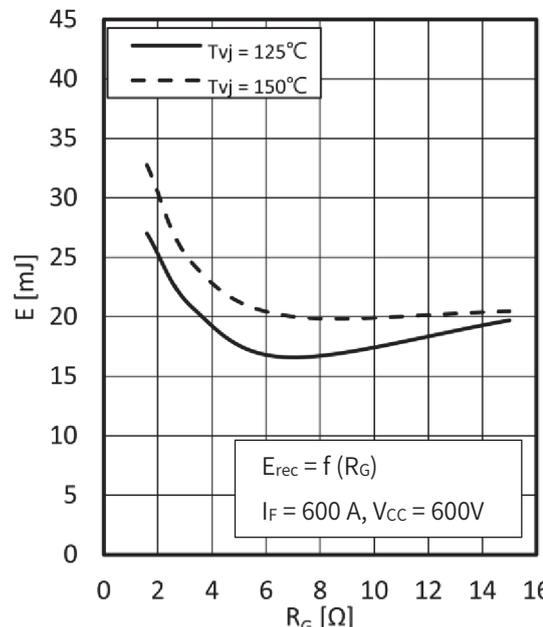
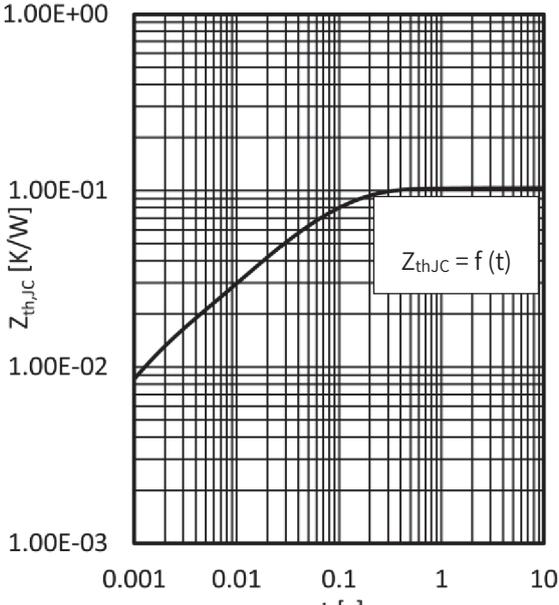
Switching losses IGBT, Inverter (typical)

Transient thermal impedance IGBT, Inverter



Reverse bias safe operating area IGBT, Inverter (RBSOA)

Forward characteristic of Diode, Inverter (typical)

	
<p>Switching losses Diode, Inverter (typical)</p>	<p>Switching losses Diode, Inverter (typical)</p>
	
<p>Transient thermal impedance Diode, Inverter</p>	

